

1MBI1600U4C-170

IGBT MODULE (U series) 1700V / 1600A / 1 in one package

Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines

Maximum Ratings and Characteristics

Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions		Maximum ratings	Units	
Collector-Emitter voltage	Vces			1700	V	
Gate-Emitter voltage	Vges			±20	V	
	lc	Continuous	Tc=25°C	2400		
Collector current			Tc=80°C	1600		
	Ic pulse	1ms	Tc=25°C	4800	^	
			Tc=80°C	3200	A	
	-lc			1600		
	-lc pulse	1ms		3200		
Collector power dissipation	Pc	1 device		9760	W	
Junction temperature	Тј			150	°C	
Storage temperature	Tstg			-40 to +125	°C	
Isolation voltage Between terminal and copper base (*1)	Viso	AC : 1min.		3400	VAC	
Screw torque	Mounting (*2)			5.75		
	Main Terminals (*2)			10	N∙m	
	Sense Terminals (*2)			2.5		

Note *1: All terminals should be connected together when isolation test will be done.

Note *2: Recommendable value : Mounting : 4.25-5.75 N·m (M6), Main Terminal : 8-10 N·m (M8), Sense Terminal : 1.7-2.5 N·m (M4)

• Electrical characteristics (at Tj= 25°C unless otherwise specified)

ltomo	Symbolo	Conditions			Characteristics		
Items	Symbols	Symbols Conditions		min.	typ.	max.	Units
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1700V		-	-	1.0	mA
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	3200	nA
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 1600mA		5.5	6.5	7.5	V
Collector-Emitter saturation voltage	V _{CE (sat)}) V _{GE} = 15V I _C = 1600A	Tj=25°C	-	2.47	2.65	V
	(main terminal)		Tj=125°C	-	2.87	-	
	V _{CE (sat)}		Tj=25°C	-	2.25	2.40	
	(chip)		Tj=125°C	-	2.65	-	
Input capacitance	Cies	V _{GE} = 0V, V _{CE} = 10V, f = 1	MHz	-	150	-	nF
Turn-on time	ton			-	1.80	-	μs
	tr	$V_{cc} = 900V, I_c = 1600A$	-	0.85	-		
Turn off time	toff	$V_{GE} = \pm 15V, Tj = 125^{\circ}C$ $R_{gon} = 2.7\Omega, R_{goff} = 1\Omega$	-	1.30	-		
urn-off time tf	tf	1 Xgon - 2.7 Sz, 1 Xgon - 1 Sz	-	0.35	-		
Forward on voltage $\begin{array}{c} V_{\text{F}} \\ (\text{main} \\ V_{\text{F}} \\ (\text{chip}) \end{array}$	VF		Tj=25°C	-	2.02	2.40	
	(main terminal)	$V_{GE} = 0V$	Tj=125°C	-	2.22	-	V
	VF	I⊧ = 1600A	Tj=25°C	-	1.80	2.15	
	(chip)		Tj=125°C	-	2.00	-	1
Reverse recovery time	trr	I⊧ = 1600A	•	-	0.35	-	μs
Lead resistance, terminal-chip (*3)	R lead			-	0.134	-	mΩ

Note *3: Biggest internal terminal resistance among arm.

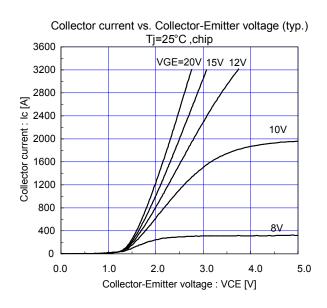
Thermal resistance characteristics

Symbolo	Conditions	Characteristics			Units
Symbols	Conditions	min.	typ.	max.	Units
Thermal resistance (1device) Rth(j-c)	IGBT	-	-	0.013	
	FWD	-	-	0.023	°C/W
Rth(c-f)	with Thermal Compound (*4)	-	0.006	-	
		Rth(j-c) IGBT FWD	SymbolsConditionsRth(j-c)IGBT-FWD-	SymbolsConditionsmin.typ.Rth(j-c)IGBTFWD	Symbols Conditions min. typ. max. Rth(j-c) IGBT - - 0.013 FWD - - 0.023

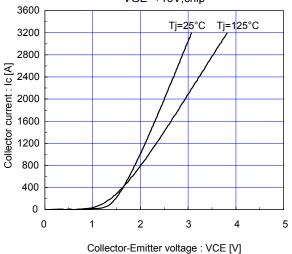
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

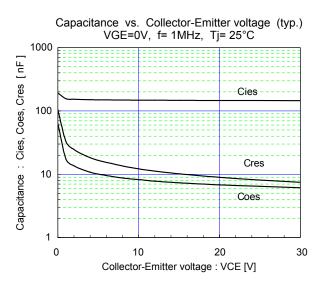


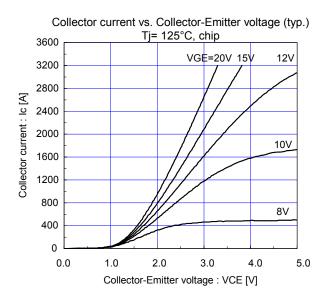
Characteristics (Representative)



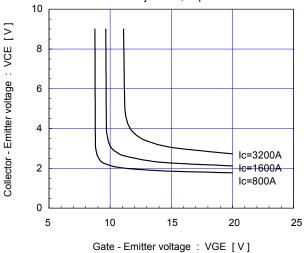
Collector-Emitter voltage vs. Gate-Emitter voltage (typ.) VGE=+15V,chip

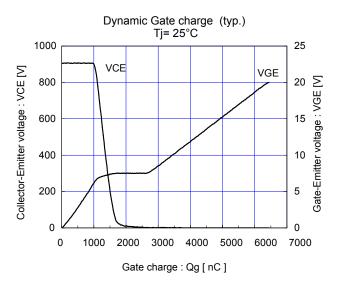






Collector-Emitter voltage vs. Gate-Emitter voltage (typ.) Tj=25°C ,chip





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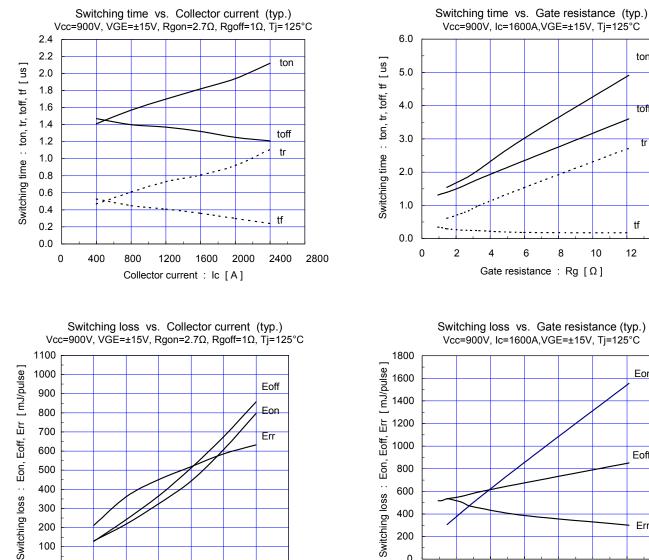
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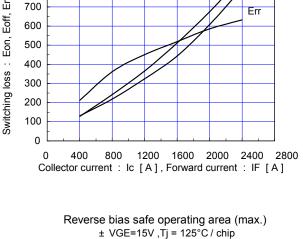
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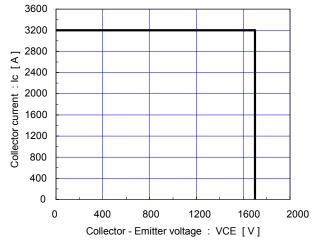
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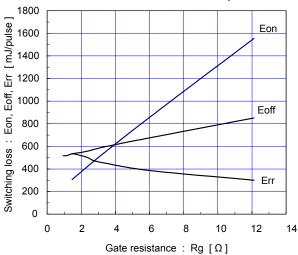
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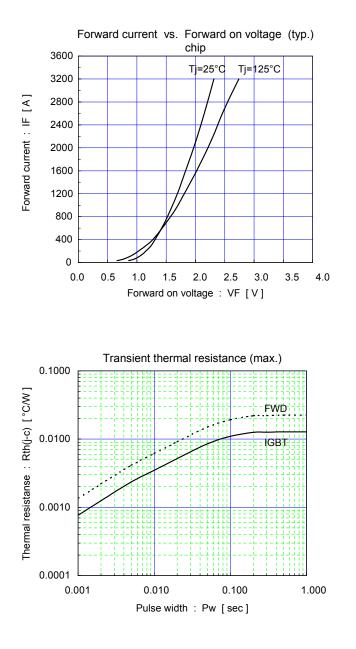
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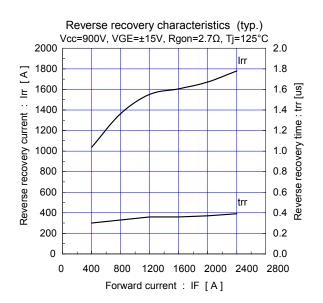




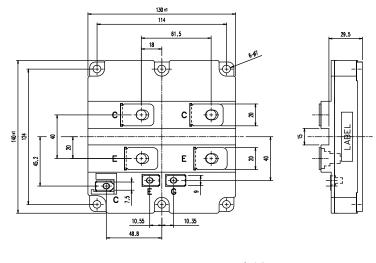


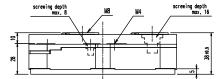




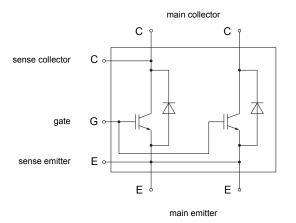


Outline Drawings, mm





Equivalent Circuit Schematic



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